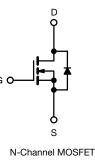
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PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	450	)
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$	1.0
Q <sub>g</sub> max. (nC)	18	
Q <sub>gs</sub> (nC)	3	
Q <sub>gd</sub> (nC)	4	
Configuration	Sing	le

# **D** Series Power MOSFET

### **FEATURES**

- Optimal design
  - Low area specific on-resistance
  - Low input capacitance (Ciss)
  - Reduced capacitive switching losses
  - High body diode ruggedness
  - Avalanche energy rated (UIS)
- Optimal efficiency and operation
  - Low cost
  - Simple gate drive circuitry
  - Low figure-of-merit (FOM): Ron x Qa
  - Fast switching
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### **APPLICATIONS**

- Consumer electronics
- Displays (LCD or plasma TV)
- Server and telecom power supplies
- SMPS
- Industrial
- Welding
- Induction heating
- Motor drives
- · Battery chargers

Package		TO-220 FL	JLLPAK		
Lead (Pb)-free		SiHF6N40	D-E3		
ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER	,		SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	400	
Gate-Source Voltage		N/	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)			V <sub>GS</sub>	30	
Continuous Durin Current /T 150 °C) 6	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		6	A
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	4	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	13	
Linear Derating Factor				0.24	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	104	mJ
Maximum Power Dissipation		PD	30	W	
Operating Junction and Storage Temperature Range	Э		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope	T <sub>J</sub> = 1	25 °C	d\//dt	24	V/ns
Reverse Diode dV/dt d			dV/dt	0.48	v/ns
Soldering Recommendations (Peak temperature) <sup>c</sup>	For	10 s		300	°C
Mounting Torque	M3 screw			0.6	Nm

a. Repetitive rating; pulse width limited by maximum junction temperature. b. V<sub>DD</sub> = 50 V, starting T<sub>J</sub> = 25 °C, L = 2.3 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 9.5 A. c. 1.6 mm from case.

d.  $I_{SD} \leq I_D,$  starting  $T_J$  = 25 °C. Limited by maximum junction temperature. e.

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		65			°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		4.1			0/10	
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	nless otherwi	se noted)				1	1	
PARAMETER	SYMBOL	TEST	CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	0 V, $I_D =$	250 µA	400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	l <sub>D</sub> = 250 μA	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}, I_D =$	250 µA	3	-	5	V
Gate-Source Leakage	I <sub>GSS</sub>	١	′ <sub>GS</sub> = ± 30	V	-	-	± 100	nA
		V <sub>DS</sub> =	400 V, V <sub>G</sub>	<sub>is</sub> = 0 V	-	-	1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 320 V	$V_{GS} = 0$	/, T <sub>J</sub> = 125 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		I <sub>D</sub> = 3 A	-	0.85	1.0	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub>	= 3 A	-	1.7	-	S
Dynamic					•			
Input Capacitance	C <sub>iss</sub>		$V_{ee} = 0.$	,	-	311	-	1
Output Capacitance	C <sub>oss</sub>	<u>۱</u>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	38	-	1 1
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	7	-	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 V to 320 V		-	44	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	54	-	1	
Total Gate Charge	Qg				-	9	18	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3 /	A, V <sub>DS</sub> = 320 V	-	3	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	4	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	12	24	
Rise Time	tr	Vpp =	: 400 V, I <sub>D</sub>	= 3 A.	-	11	22	
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	10 V, R <sub>g</sub>	= 9.1 Ω	-	14	28	- ns
Fall Time	t <sub>f</sub>	1			-	8	16	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	1.9	-	Ω	
Drain-Source Body Diode Characteristic		<u> </u>				1	1	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the	MOSFET symbol		-	-	6	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse		-	-	24	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>.1</sub> = 25 °C	C, I <sub>S</sub> = 3 A	, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				-	236	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25	°C, I <sub>F</sub> = I 00 A/µs <sup>, \</sup>	$_{S} = 3 A,$	-	1.1	-	μC
Reverse Recovery Current	I <sub>BBM</sub>	- ai/dt = 1	00 Α/μs <sup>, ν</sup>	<sub>R</sub> = 20 V	-	9	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

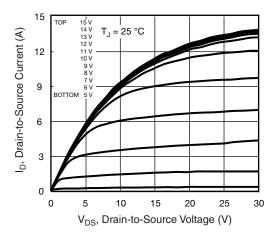


Fig. 1 - Typical Output Characteristics

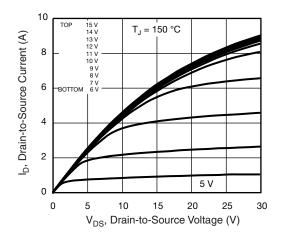
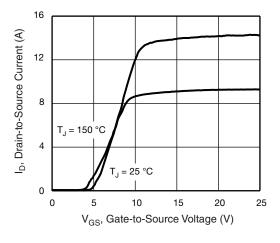


Fig. 2 - Typical Output Characteristics





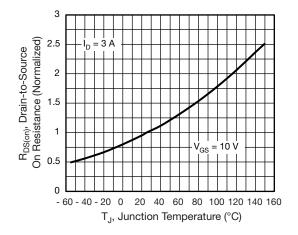


Fig. 4 - Normalized On-Resistance vs. Temperature

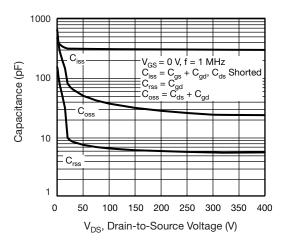


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

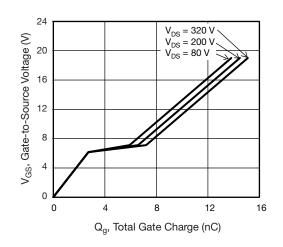


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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**3** For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91501

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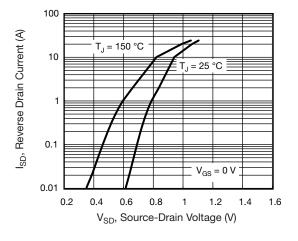


Fig. 7 - Typical Source-Drain Diode Forward Voltage

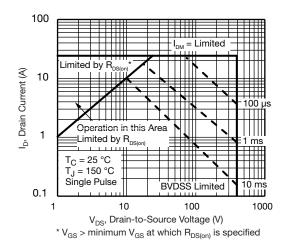


Fig. 8 - Maximum Safe Operating Area

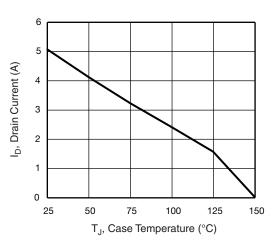


Fig. 9 - Maximum Drain Current vs. Case Temperature

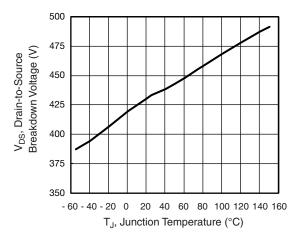
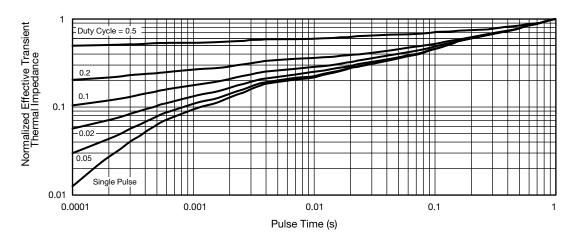


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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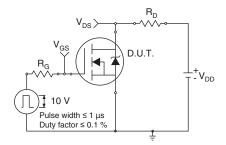


Fig. 12 - Switching Time Test Circuit

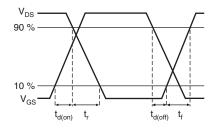


Fig. 13 - Switching Time Waveforms

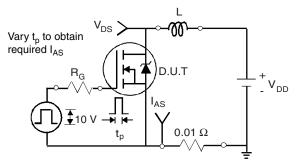


Fig. 14 - Unclamped Inductive Test Circuit

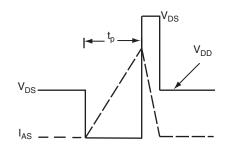


Fig. 15 - Unclamped Inductive Waveforms

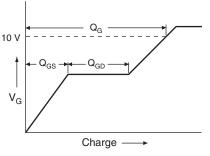


Fig. 16 - Basic Gate Charge Waveform

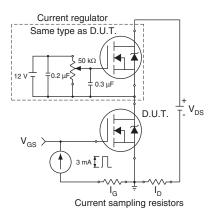


Fig. 17 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit

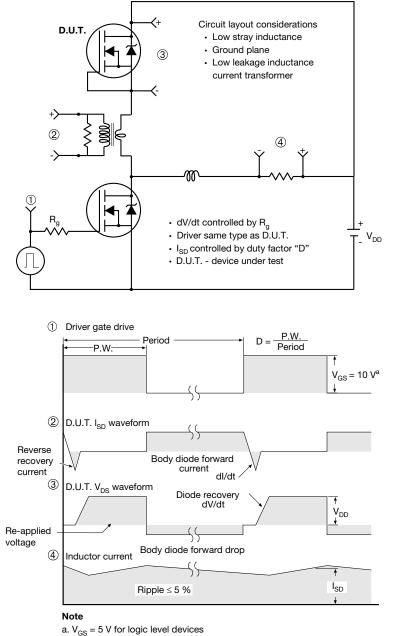


Fig. 18 - For N-Channel

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# **TO-220 FULLPAK (High Voltage)**

### **OPTION 1: FACILITY CODE = 9**



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

#### Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
  6. Facility code will be the 1<sup>st</sup> character located at the 2<sup>nd</sup> row of the unit marking

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### **OPTION 2: FACILITY CODE = Y**



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100	) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

#### Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet  $C_{pk} > 1.33$ 

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1<sup>st</sup> character located at the 2<sup>nd</sup> row of the unit marking

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